



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Yao, et al. Docket No.: TSM02-1098  
Serial No.: 10/602,147 Art Unit: 2812  
Filed: June 24, 2003 Examiner: Andre Stevenson  
For: Test Patterns for Measurement of Effective Vacancy Diffusion Area

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Date of Deposit: March 16, 2004

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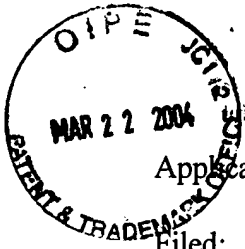
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Respectfully submitted,

*Natalie Swider*

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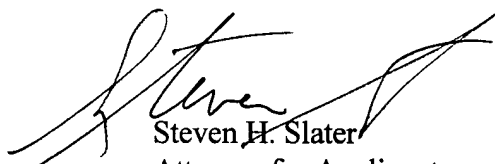
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Dear Sir:

Applicants wish to bring to the attention of the Patent and Trademark Office the information noted on the enclosed combined form PTO/SB/08A & 08B that may be considered material to the examination of the above-identified application.

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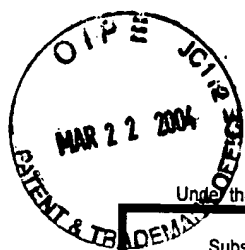
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PTO/SB/08a (08-03)

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STATEMENT BY APPLICANT**

(Use as many sheets as necessary)

**Complete if Known**

|                        |                     |
|------------------------|---------------------|
| Application Number     | 10/602,147          |
| Filing Date            | 6/24/2003           |
| First Named Inventor   | Yao, et al.         |
| Art Unit               | 2812                |
| Examiner Name          | Stevenson, Andre C. |
| Attorney Docket Number | TSM02-1098          |

Sheet 1 of 1

**U.S. PATENT DOCUMENTS**

| Examiner<br>Initials* | Cite<br>No. <sup>1</sup> | Document Number                            | Publication Date<br>MM-DD-YYYY | Name of Patentee or<br>Applicant of Cited Document | Pages, Columns, Lines, Where<br>Relevant Passages or Relevant<br>Figures Appear |
|-----------------------|--------------------------|--------------------------------------------|--------------------------------|----------------------------------------------------|---------------------------------------------------------------------------------|
|                       |                          | Number - Kind Code <sup>2</sup> (if known) |                                |                                                    |                                                                                 |
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**FOREIGN PATENT DOCUMENTS**

| Examiner<br>Initials* | Cite<br>No. <sup>1</sup> | Foreign Patent Document                                                             | Publication Date<br>MM-DD-YYYY | Name of Patentee or<br>Applicant of Cited Document | Pages, Columns, Lines,<br>Where Relevant Passages<br>or Relevant Figures Appear | T <sup>6</sup> |
|-----------------------|--------------------------|-------------------------------------------------------------------------------------|--------------------------------|----------------------------------------------------|---------------------------------------------------------------------------------|----------------|
|                       |                          | Country Code <sup>3</sup> - Number <sup>4</sup> - Kind Code <sup>5</sup> (if known) |                                |                                                    |                                                                                 |                |
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**NON PATENT LITERATURE DOCUMENTS**

| Examiner<br>Initials* | Cite<br>No. | Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item<br>(book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher,<br>city and/or country where published. | T <sup>2</sup> |
|-----------------------|-------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|
|                       |             |                                                                                                                                                                                                                                                                       |                |
|                       | 1           | OGAWA, E.T., et al., "Stress-Induced Voiding under Vias Connected to Wide Cu Metal Leads," IEEE<br>International Reliability Physics Symposium Proceedings, 40 <sup>th</sup> Annual, 2002, pp. 312-321.                                                               |                |
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|-----------------------|--|--------------------|--|
| Examiner<br>Signature |  | Date<br>Considered |  |
|-----------------------|--|--------------------|--|

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